L Number	Hits	Search Text	DB	Time stamp
17	3923	<pre>(photosensitive or (resist near4 film\$1)) and (mask\$4 or pattern\$1) and (substrate\$1 or workpiece\$1) and ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1))</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/16 12:54
18	306	<pre>((photosensitive or (resist near4 film\$1)) and (mask\$4 or pattern\$1) and (substrate\$1 or workpiece\$1) and ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1)) and ((photosensitive or (resist near4 film\$1)) same (mask\$4 or pattern\$1) same ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1))</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/16 13:01
20	42	<pre>(((photosensitive or (resist near4 film\$1)) and (mask\$4 or pattern\$1) and (substrate\$1 or workpiece\$1) and ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1))) and ((photosensitive or (resist near4 film\$1)) same (mask\$4 or pattern\$1) same ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1))) and (347/\$.ccls.)</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/16 13:01
27	25	<pre>((((photosensitive or (resist near4 film\$1)) and (mask\$4 or pattern\$1) and (substrate\$1 or workpiece\$1) and ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1)) and ((photosensitive or (resist near4 film\$1)) same (mask\$4 or pattern\$1) same ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1))) and (347/\$.ccls.)) and align\$4</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/16 13:01
28	13	((((photosensitive or (resist near4 film\$1)) and (mask\$4 or pattern\$1) and (substrate\$1 or workpiece\$1) and ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1)) and ((photosensitive or (resist near4 film\$1)) same (mask\$4 or pattern\$1) same ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1))) and (347/\$.ccls.)) and align\$4) and mov\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/16 13:03
29	8	<pre>((((((photosensitive or (resist near4 film\$1)) and (mask\$4 or pattern\$1) and (substrate\$1 or workpiece\$1) and ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1))) and ((photosensitive or (resist near4 film\$1)) same (mask\$4 or pattern\$1) same ((deposit\$4 or eject\$4) with (ink\$1 or liquid\$1 or fluid\$1))) and (347/\$.ccls.)) and align\$4) and mov\$4) and rotat\$4</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/16 13:02

3.0	7.4		,	
30	34	///this	USPAT;	2004/01/16
		film\$1)) and (mask\$4 or pattern\$1) and	US-PGPUB;	13:03
		(substrate\$1 or workpiece\$1) and	EPO; JPO;	
		((deposit\$4 or eject\$4) with (ink\$1 or	DERWENT	
		liquid\$1 or fluid\$1))) and		
		((photosensitive or (resist near4		
		film\$1)) same (mask\$4 or pattern\$1) same		
		((deposit\$4 or eject\$4) with (ink\$1 or		
		liquid\$1 or fluid\$1)))) and		
		(347/\$.ccls.)) not ((((((photosensitive		
		or (resist near4 film\$1)) and (mask\$4 or		
		pattern\$1) and (substrate\$1 or		
		<pre>workpiece\$1) and ((deposit\$4 or eject\$4)</pre>		
	İ	with (ink\$1 or liquid\$1 or fluid\$1))) and		
		((photosensitive or (resist near4		
		film\$1)) same (mask\$4 or pattern\$1) same		
		((deposit\$4 or eject\$4) with (ink\$1 or		
		liquid\$1 or fluid\$1)))) and		
		(347/\$.ccls.)) and align\$4) and mov\$4)		
		and rotat\$4)		